EAST Search History

EAST Search History (Prior Art)

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
86	544	((Semiconductor or substrate or wafer) near5 (wash or washer or washing or olean or deaner or deaning or clean or substrate or washer or or deaning or clean or	US-PATEUR US-PATEURSOCA; EPO; JPO; DEPWENT; IBM_TDB	OR	ON	2009/12/19

	or wafer) near5 (wash or	USPAT:	1	1	140.40
	E b b		1		10:12
	washed or washer or	USOCR; EPO;		•	
	washing or clean or cleaner	JPO;	ı		
	or cleaning or cleaned or	DERWENT;			
	decontaminat\$4 or rins\$4 or	IBM_TDB			
	etch\$4)) AND ((wash or				
	washed or washer or				
	washing or clean or cleaner				
	or cleaning or cleaned or				
	decontaminat\$4 or rins\$4 or				
	etch\$4) NEAR5				
	(COMPARTMENT OR				
	CHAMBER OR CONTAINER				
	OR RECEPTACLE OR VESSEL		1		
	OR TUB OR VAT OR TANK				
	OR BATH OR BOWL)) and				
	((IPA or alcohol) near5		1		
	(GASEOUS OR gas or vapor				
	\$4 OR VAPOUR\$4) near5				
	(supply or source or spray\$4	9			
	or nozzle or manifold or jet				
	\$4 or inlet)) AND ((DRY\$4				
	OR DRYER OR DRIER OR				
	DRIED) NEAR5 (NITROGEN				
	OR COMPARTMENT OR				
	CHAMBER OR ENCLOSURE				
	OR COVER OR COVERING				
	SHELL OR HOOD)) AND				
	((semiconductor or substrate				
	or wafer) near5 (RAIS\$4 OR				
	LIFT\$4 OR ELEVAT\$4 OR UP UPWARD\$4)) AND				
	((semiconductor or substrate				
	or wafer) near5 (LOWER\$4				
	OR DIPS4 OR DOWNS4 OR				
	IMMERS\$4 OR SUBMERG\$4		1		
	OR SUBMERS\$4)) AND ((DRY				
	\$4 OR DRYER OR DRIER OR				
	ENCLOSURE OR COVER OR				
	COVERING SHELL OR HOOD				
	OR VAPOUR OR GAS OR				
	GASEOUS OR VAPOR OR				
	FUMES) NEAR5 (EXHAUST\$4				
	OR PURG\$4 OR VENT\$4 OR				
	VENTILAT\$4 OR VACUUM\$4				
	OR "LOW PRESSURE" OR				
	EVACUAT\$4 OR				
	WITHDRAWN OR SUCTION			-	
	\$4 OR SUCK\$4))				
		•	•		4

S32	380	[((semiconductor or substrate or wafer) near5 (DRY\$4 OR DRY\$6 OR DRIED OR DRIED OR DRIED OR Wash or washed or washer or washing or clean or cleaner or cleaning or cleaned or decontaminat\$4 or rins\$4 or etch\$4)) AND ((DRY\$4 OR DRY\$E OR DRIED OR washing or clean or deaner or washing or clean or cleaner or deaning or cleaned or decontaminat\$4 or rins\$4 or etch\$4) NEAR5 (LIQUID OR ACID OR WATER OR ETCHANT OR ALCOHOL OR ETCHANT OR ALCOHOL OR GAS OR GASEOUS OR VAPOR OR FUMES) NEAR5 (EXHAUST\$4 OR PURD\$4 OR WITHDRAWN OR SUCTION\$4 OR SUCTION\$4 OR SUCTION\$4 OR SUCTION\$4 OR SUCTION\$4 OR SUCTION\$5 OR SUCTIO	US-PGPUB; USPAT; USOAR; PFPS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/12/20 11:58
942	236	((Semiconductor or substrate or wafer) near5 (DRY\$4 OR DRYER OR DRIED OR wash or washing or dean or cleaner or cleaning or cleaner or decontaminats4 or rins\$4 or etch\$4) NEAP5 ((COMPARTMENT OR CHAMBER OR DE WERT OR COYER OR COYE	(US-PCPUB; USPAT; USPAT; USCOR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2009/12/20 15:43

4		IPA)) AND ((VAPOUR OR GAS OR GASEOUS OR VAPON OR FUMES) NEARS (EXHAUSTS4 OR PURGS4 OR VENTS4 OR SUCTIONS4 OR SUCTIONS4 OR SUCTIONS4 OR SUCTIONS54 OR ANGILLIARY OR AUXILIARY OR AUXILIARY OR AUXILIARY OR AUXILIARY OR OR EXTRA OR BACKUP OR ASSISTS4 OR COMPLEMENTARY)) AND ((VAPOUR OR GAS OR GASEOUS OR VAPOR OR FUMES) NEARS (EXHAUSTS4 OR PURGS4 OR VENTS4 OR VENTS4 OR VENTS4 OR VENTS4 OR VENTS4 OR VENTS4 OR SUCTION S4 OR SUCKS4 OR ASSIRET OR EVACUATS4 OR OR SUCKS4 OR ASSIRET OR CUMES OR SUCKS4 OR ASSIRET OR FUNCTS4 OR SUCKS4 OR ASSIRET OR OR SUCKS4 OR ASSIRET OR COMPARTMENT OR CHAMBER OR ENCLOSURE OR COVER OR COV				
S70	431	134/104.2.COLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/12/20 20:13
S72	598	134/902.CQLS.	USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/12/20 20:14
S73	1769	134/902.OOLS.	USPAT	OR	ON	2009/12/20 20:14
S74	375	134/902.COLS.	US-PGPUB	OR	ON	2009/12/20 20:14

12/21/09 11:59:46 AM

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